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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

OCT 27 2003

re application of

Akihisa HONGO et al.

Serial No. 09/762,582

Filed April 12, 2001

Confirmation No. 5731

Docket No. 2001_0133A

Group Art Unit 1753

Examiner Brian Mutschler

SUBSTRATE PLATING
METHOD AND APPARATUS

PETITION FOR EXTENSION OF TIME

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

Petition hereby is made for a three month extension of time to respond to the communication of May 7, 2003.

The fee of \$950.00 is

- (X) submitted herewith.
() to be charged to Deposit Account No. 23-0975. A duplicate copy of this Petition is enclosed.
() Small entity status of this application is established by a Small Entity Status Assertion which
() is enclosed.
() has been previously submitted.

Respectfully submitted,

Akihisa HONGO et al.

10/29/2003 KBETEMA1 00000029 09762582

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